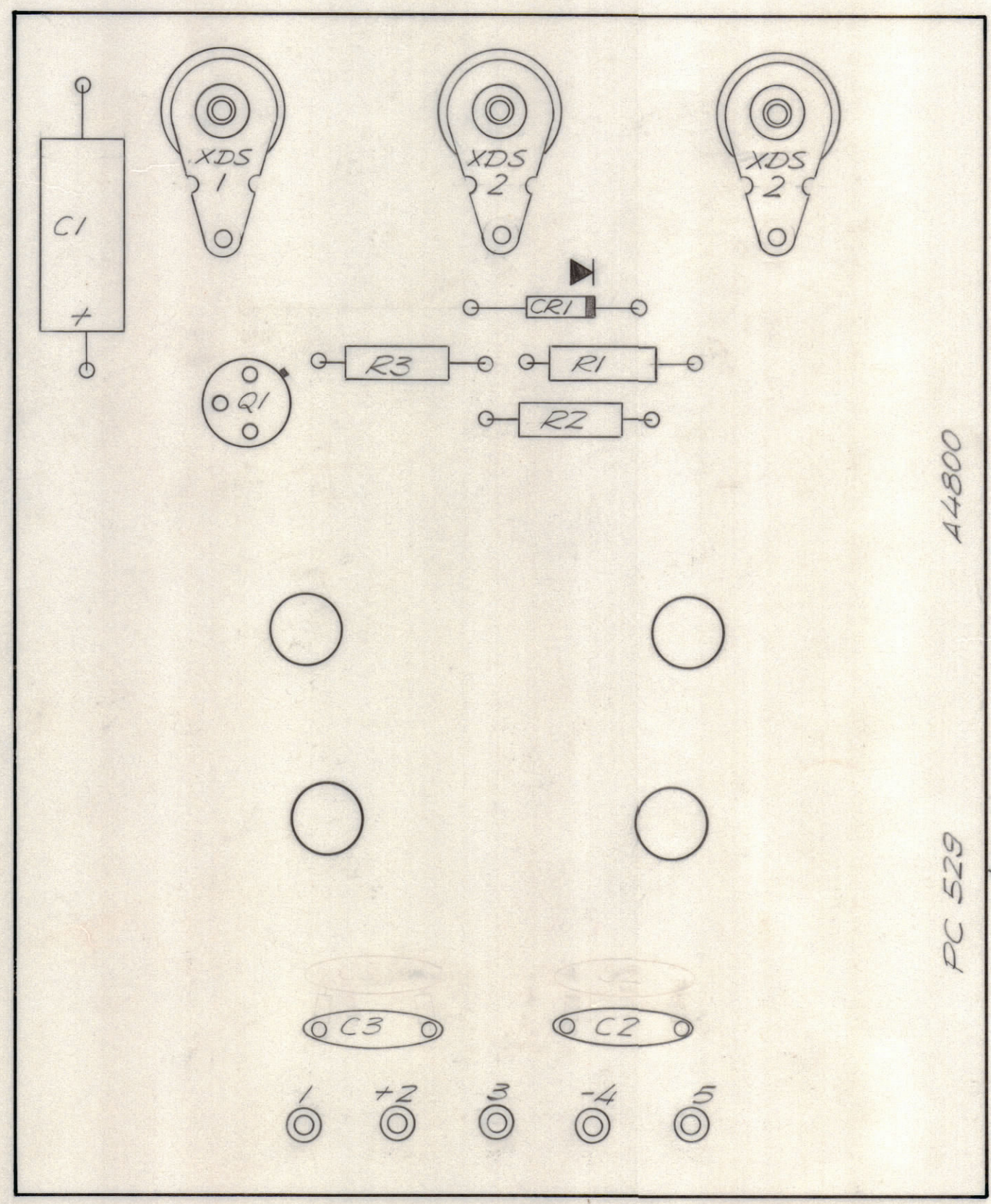
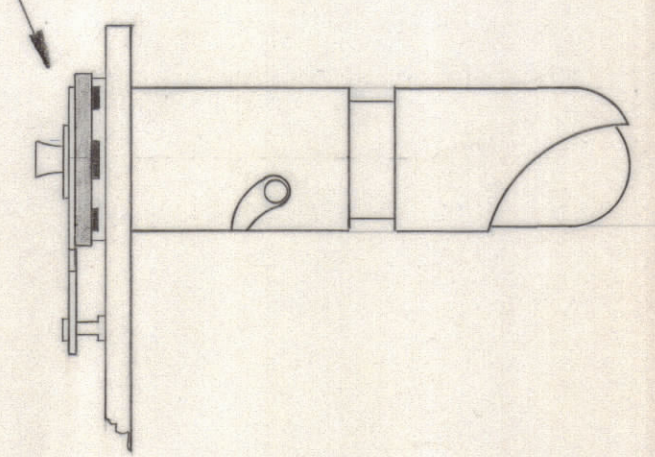


REVISIONS							
E.M.N.NO	DRAFT	CHKD	ZONE	LTR	DESCRIPTION	DATE	APPROVED
	GE			X	EXP. RELEASE	2-24-70	LD
	GE			Ø	ORIGINAL RELEASE FOR PRODUCTION	2-25-70	LD
19858	GE			A	ADDED TERM MTG. DETAIL	5/20/70	LD



SOLDER AFTER MOUNTING



SOLDER TERMINALS TO PADS BOTH SIDES OF BOARD. TYP 8 PLACES

ASSEMBLY NOTES:

1. TO MOUNT COMPONENTS INSERT LEADS THROUGH PLATED THRU-HOLES.
2. CAUTION, WHEN APPLYING HEAT AND SOLDER TO LEAD AND FOIL.
3. CLEAN AND INSPECT AS PER TMC SPEC 5676
4. FOR ELECTRICAL COMPONENT PART NUMBERS REFER TO NPL A 4800.
5. USE SYMBOL NUMBERS FOR ASSEMBLY REF.

2	PALA 10 K AX5083	A 4800
QTY / UNIT	MODEL USED ON	ASS'Y NO.
APPLICATION		
CODE		

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QTY. REQ.	ITEM	PART NO.	DESCRIPTION	SYMBOL
1	3	PX 829-3	PAD MOUNTING, TRANSISTOR	
X	2	BS 100	SOLDER TIN ALLOY	
1	1	PC 529	PRINTED CIRCUIT BOARD	

F. BUDETTI				LIST OF MATERIAL	
FINAL APPROVAL	DATE	THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK <i>ASSY. PRINTED CIRCUIT B.D.</i> <i>PA PLATE OVLD.</i> <i>PA SCREEN OVLD.</i>			
<i>F.B.</i>	2-24-70				
MECH. DES.	DATE				
<i>F. Tuller</i>	2/24/70				
ELECT. DES.	DATE				
<i>F. Tuller</i>	2/24/70				
CHECKED	DATE				
DRAWN	DATE				
<i>EVANGELIST</i>	2/9/70				
MATERIAL	SIZE		CODE IDENT NO.	DWG NO.	ISSUE
FINISH	C		82679	A 4800	A
SCALE 2:1			SHEET OF		